

Electronic Patent Application Fee Transmittal

Application Number:	10553470			
Filing Date:	19-May-2006			
Title of Invention:	MONITORING THE REDUCTION IN THICKNESS AS MATERIAL IS REMOVED FROM A WAFER COMPOSITE AND TEST STRUCTURE FOR MONITORING REMOVAL OF MATERIAL			
First Named Inventor/Applicant Name:	Ralf Lerner			
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Attorney Docket Number:	60291.000041			
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Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
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